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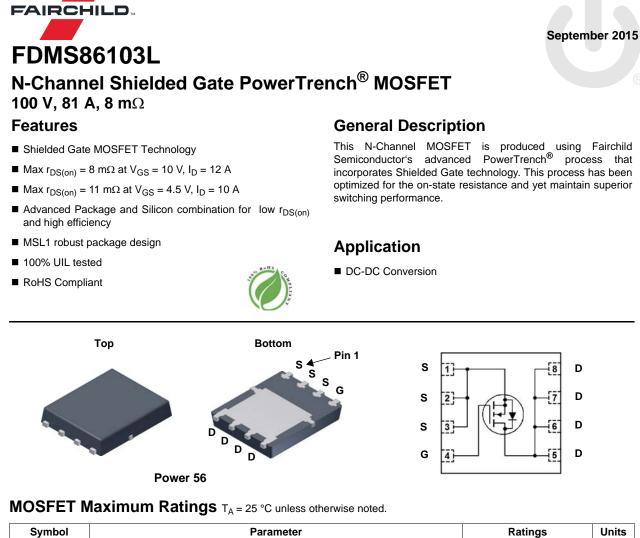


## **ON Semiconductor**®

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Please note: As part of the Fairchild Semiconductor integration, some of the Fairchild orderable part numbers will need to change in order to meet ON Semiconductor's system requirements. Since the ON Semiconductor product management systems do not have the ability to manage part nomenclature that utilizes an underscore (\_), the underscore (\_) in the Fairchild part numbers will be changed to a dash (-). This document may contain device numbers with an underscore (\_). Please check the ON Semiconductor website to verify the updated device numbers. The most current and up-to-date ordering information can be found at <a href="mailto:www.onsemi.com">www.onsemi.com</a>. Please email any questions regarding the system integration to <a href="mailto:Fairchild\_questions@onsemi.com">Fairchild\_questions@onsemi.com</a>.

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Symbol	Parame	eter		Ratings	Units
V <sub>DS</sub>	Drain to Source Voltage			100	V
V <sub>GS</sub>	Gate to Source Voltage			±20	V
ID	Drain Current -Continuous	T <sub>C</sub> = 25 °C	(Note 5)	81	
	Drain Current -Continuous	T <sub>C</sub> = 100 °C	(Note 5)	51	Α
	-Continuous	T <sub>A</sub> = 25 °C		12	A
	-Pulsed		(Note 4)	414	
E <sub>AS</sub>	Single Pulse Avalanche Energy		(Note 3)	312	mJ
P <sub>D</sub>	Power Dissipation	T <sub>C</sub> = 25 °C	= 25 °C 104		w
	Power Dissipation	T <sub>A</sub> = 25 °C		2.5	VV
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150	°C

#### **Thermal Characteristics**

$R_{\theta JC}$	Thermal Resistance, Junction to Case		1.2	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/ W

#### **Package Marking and Ordering Information**

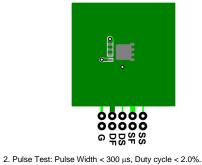
Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS86103L	FDMS86103L	Power 56	13 "	12 mm	3000 units

FDMS86103L N-Channel Shielded Gate PowerTrench<sup>®</sup> MOSFET

Symbol	Parameter	Test Conditions	Min.	Тур.	Max.	Units	
Off Chara	cteristics						
BV <sub>DSS</sub>	Drain to Source Breakdown Voltage	$I_{D} = 250 \ \mu A, V_{GS} = 0 \ V$	100			V	
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		68		mV/°C	
IDSS	Zero Gate Voltage Drain Current	$V_{DS} = 80 V, V_{GS} = 0 V$			1	μA	
I <sub>GSS</sub>	Gate to Source Leakage Current	$V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$			±100	nA	
	cteristics			1			
V <sub>GS(th)</sub>	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$	1.0	1.9	3.0	V	
$\Delta V_{GS(th)}$	Gate to Source Threshold Voltage Temperature Coefficient	$I_D = 250 \ \mu$ A, referenced to 25 °C		-7		mV/°C	
r <sub>DS(on)</sub>	Static Drain to Source On Resistance	V <sub>GS</sub> = 10 V, I <sub>D</sub> = 12 A		6.4	8	mΩ	
		$V_{GS} = 4.5 \text{ V}, I_{D} = 10 \text{ A}$		8.4	11		
		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 12 \text{ A}, \text{ T}_{J} = 125 \text{ °C}$		10.6	14	1	
9 <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> = 5 V, I <sub>D</sub> = 12 A		59		S	
Dynamic	Characteristics						
C <sub>iss</sub>	Input Capacitance			2790	3710	pF	
C <sub>oss</sub>	Output Capacitance	──V <sub>DS</sub> = 50 V, V <sub>GS</sub> = 0 V, f = 1 MHz		469	625	pF	
C <sub>rss</sub>	Reverse Transfer Capacitance			22	35	pF	
Rg	Gate Resistance			1.3		Ω	
Switching	Characteristics						
t <sub>d(on)</sub>	Turn-On Delay Time			13	23	ns	
t <sub>r</sub>	Rise Time	V <sub>DD</sub> = 50 V, I <sub>D</sub> = 12 A,		7.2	15	ns	
t <sub>d(off)</sub>	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, \text{ R}_{GEN} = 6 \Omega$		35	57	ns	
t <sub>f</sub>	Fall Time			6	13	ns	
Qg	Total Gate Charge	$V_{GS} = 0 V$ to 10 V		43	60	nC	
Q <sub>g</sub>	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V}$ $V_{DD} = 50 \text{ V},$		23	32	nC	
Q <sub>gs</sub>	Gate to Source Charge	I <sub>D</sub> = 12 A		7.5		nC	
Q <sub>gd</sub>	Gate to Drain "Miller" Charge			7		nC	
Drain-Soເ	Irce Diode Characteristics						
		$V_{GS} = 0 V, I_S = 2 A$ (Note 2)		0.70	1.2		
V <sub>SD</sub>	Source to Drain Diode Forward Voltage	$V_{GS} = 0 V, I_S = 12 A$ (Note 2)		0.78	1.3	V	
t <sub>rr</sub>	Reverse Recovery Time			57	90	ns	
Q <sub>rr</sub>	Reverse Recovery Charge	— I <sub>F</sub> = 12 A, di/dt = 100 A/μs		68	108	nC	

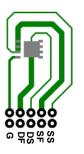
Notes:

1.  $R_{0,IA}$  is determined with the device mounted on a 1 in<sup>2</sup> pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material.  $R_{0,IC}$  is guaranteed by design while  $R_{0,CA}$  is determined by the user's board design.



3. Starting T<sub>J</sub> = 25 °C, L = 1 mH, I<sub>AS</sub> = 25 A, V<sub>DD</sub> = 90 V, V<sub>GS</sub> = 10 V 4. Pulsed Id please refer to Fig 11 SOA graph for more details.

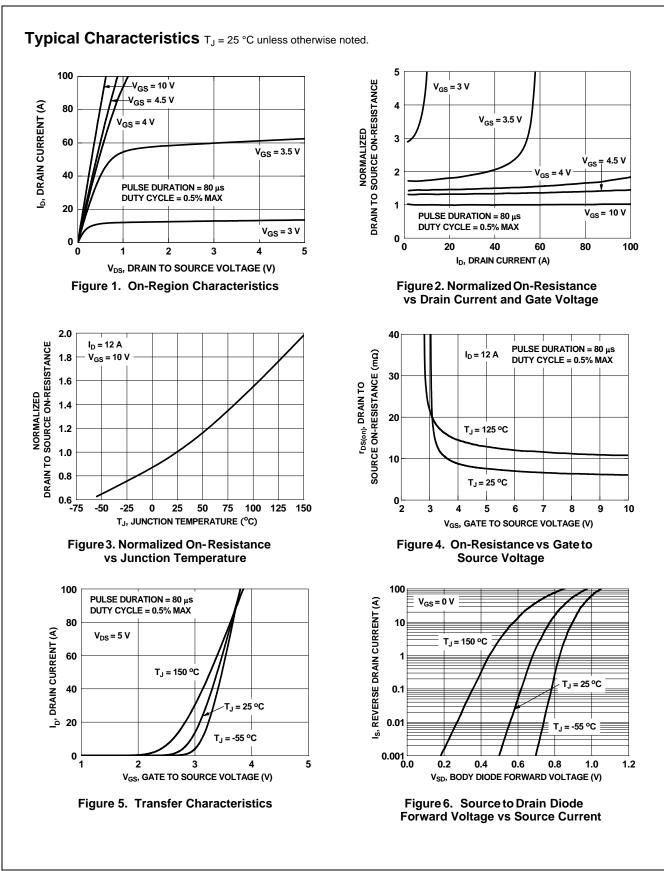
a. 50 °C/W when mounted on a 1  $in^2$  pad of 2 oz copper.



b. 125 °C/W when mounted on a minimum pad of 2 oz copper.

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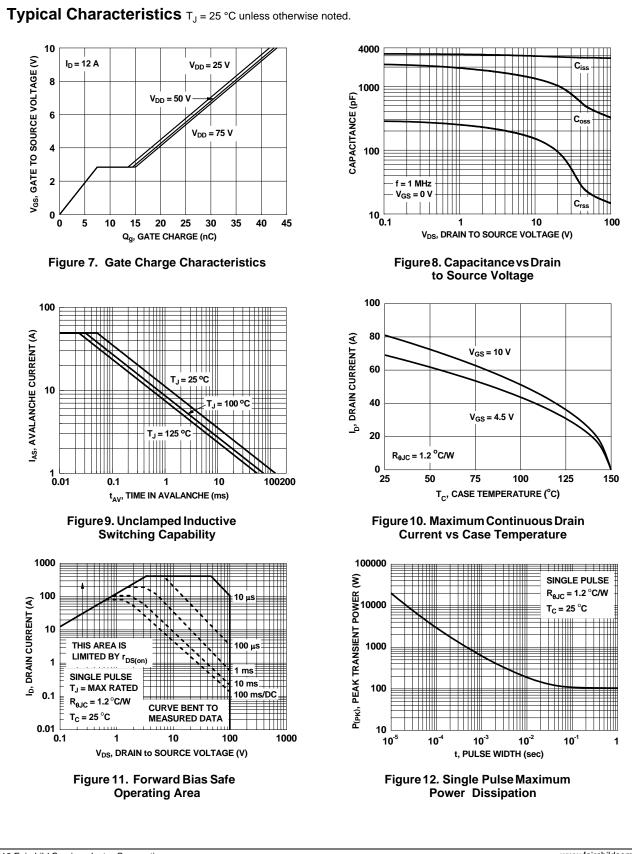
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro-mechanical application board design.



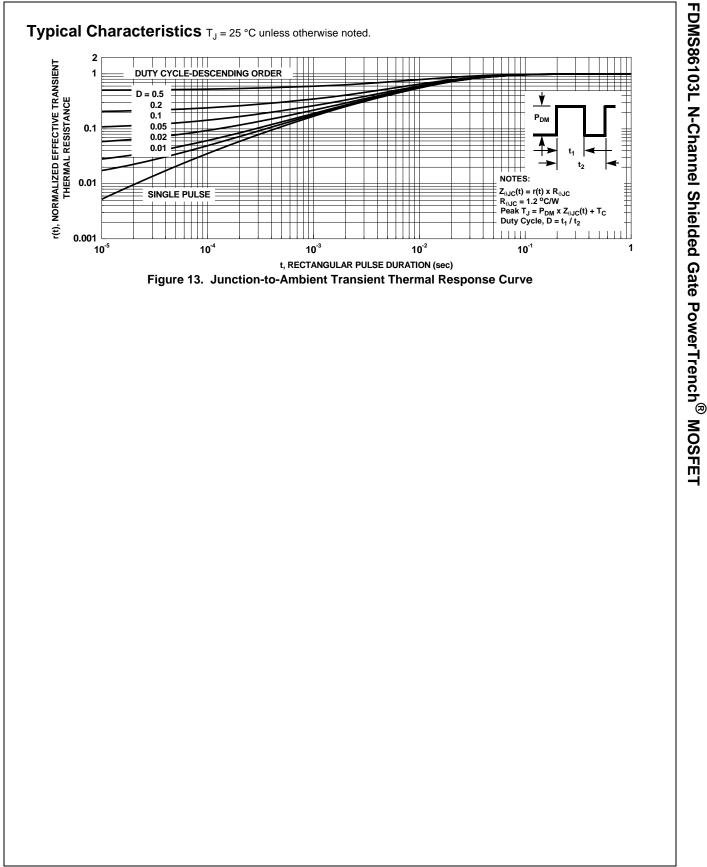
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